Package Options Include Plastic Small-Outline (D) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs

description

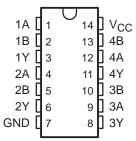
These devices contain four independent 2-input positive-AND gates. They <u>perform</u> the Boolean functions $Y = A \cdot B$ or $Y = \overline{A} + \overline{B}$ in positive logic.

The SN54ALS08 and SN54AS08 are characterized for operation over the full military temperature range of -55°C to 125°C. The SN74ALS08 and SN74AS08 are characterized for operation from 0°C to 70°C.

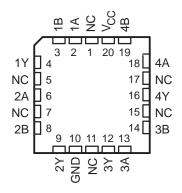
FUNCTION TABLE (each gate)

INP	UTS	OUTPUT
Α	В	Y
Н	Н	Н
L	Χ	L
Х	L	L

SN54ALS08, SN54AS08 . . . J PACKAGE SN74ALS08, SN74AS08 . . . D OR N PACKAGE (TOP VIEW)



SN54ALS08, SN54AS08 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

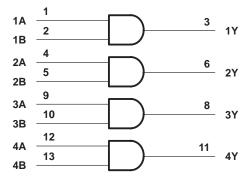
logic symbol†

1 /	1	&	3	
18	2	α		1Y
18	4			
1A 1B 2A 2B	5		6	2Y
2B	9			
3A	10		8	3Y
3B	12			
4A 4B	13		11	4Y
4B				• •

[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Pin numbers shown are for the D, J, and N packages.

logic diagram (positive logic)



SN54ALS08, SN54AS08, SN74ALS08, SN74AS08 QUADRUPLE 2-INPUT POSITIVE-AND GATES

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V _{CC}	
Input voltage, V _I	7 V
Operating free-air temperature range, TA: SN54ALS08	–55°C to 125°C
SN74ALS08	
Storage temperature range	65°C to 150°C

recommended operating conditions

		SN54ALS08			SI	UNIT			
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT	
Vcc	Supply voltage	4.5	5	5.5	4.5	5	5.5	V	
VIH	High-level input voltage	2			2			V	
V	Low level input veltage			0.8‡			0.8	V	
VIL	Low-level input voltage			0.7§				\ \ \	
lOH	High-level output current			-0.4			-0.4	mA	
l _{OL}	Low-level output current			4			8	mA	
TA	Operating free-air temperature	-55		125	0		70	°C	

[‡] Applies over temperature range -55°C to 70°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST C	TEST CONDITIONS			8	SN74ALS08			UNIT
PARAMETER	1531 C				MAX	MIN	TYP¶	MAX	UNII
VIK	V _{CC} = 4.5 V,	I _I = -18 mA			-1.5			-1.5	V
Voн	$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V},$	$I_{OH} = -0.4 \text{ mA}$	V _{CC} -2			V _{CC} -2	2		V
Vol	V _{CC} = 4.5 V	I _{OL} = 4 mA		0.25	0.4		0.25	0.4	V
VOL	VCC = 4.5 V	I _{OL} = 8 mA					0.35	0.5	V
ΙĮ	V _{CC} = 5.5 V,	V _I = 7 V			0.1			0.1	mA
lіН	$V_{CC} = 5.5 V,$	V _I = 2.7 V			20			20	μΑ
Ι _Ι L	$V_{CC} = 5.5 \text{ V},$	V _I = 0.4 V			-0.1			-0.1	mA
IO#	$V_{CC} = 5.5 \text{ V},$	V _O = 2.25 V	-20		-112	-30		-112	mA
Іссн	$V_{CC} = 5.5 V,$	V _I = 4.5 V		1.3	2.4		1.3	2.4	mA
ICCL	$V_{CC} = 5.5 V,$	V _I = 0		2.2	4		2.2	4	mA

[¶] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.



[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

[§] Applies over temperature range 70°C to 125°C

[#]The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, IOS.

switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	C _L R _L	= 50 pF = 500 £		V,	UNIT
			SN54ALS08		SN74ALS08		
			MIN	MAX	MIN	MAX	
^t PLH	A or B	V	2	14	4	14	ns
tPHL	AUID	ſ	2	12.5	3	10	110

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage, V _{CC}			 7 V
Input voltage, V _I			 7 V
	nperature range, T _A : SN54A		
	SN74/	\S08	 0°C to 70°C
Storage temperature	range		 -65°C to 150°C

[‡] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

		SN54AS08			SN74AS08			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	UNII
VCC	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	2			2			V
VIL	Low-level input voltage			0.8			0.8	V
ЮН	High-level output current			-2			-2	mA
loL	Low-level output current			20			20	mA
TA	Operating free-air temperature	-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DADAMETED	TEST O	TEST CONDITIONS		SN54AS08			SN74AS08		
PARAMETER	lESI C	ONDITIONS	MIN	TYP§	MAX	MIN	TYP§	MAX	UNIT
VIK	V _{CC} = 4.5 V,	$I_{I} = -18 \text{ mA}$			-1.2			-1.2	V
Voн	$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V},$	$I_{OH} = -2 \text{ mA}$	V _{CC} -2	2		V _{CC} -2	2		V
v_{OL}	$V_{CC} = 4.5 V,$	$I_{OL} = 20 \text{ mA}$		0.35	0.5		0.35	0.5	V
lį	$V_{CC} = 5.5 V,$	V _I = 7 V			0.1			0.1	mA
lіН	$V_{CC} = 5.5 V,$	V _I = 2.7 V			20			20	μΑ
I _{IL}	$V_{CC} = 5.5 V,$	V _I = 0.4 V			-0.5			-0.5	mA
ΙΟ [¶]	V _{CC} = 5.5 V,	V _O = 2.25 V	-30		-112	-30		-112	mA
IССН	V _{CC} = 5.5 V,	V _I = 4.5 V		5.8	9.3		5.8	9.3	mA
ICCL	$V_{CC} = 5.5 V,$	V _I = 0		14.9	24		14.9	24	mA

[§] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.



The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, Ios.

SN54ALS08, SN54AS08, SN74ALS08, SN74AS08 QUADRUPLE 2-INPUT POSITIVE-AND GATES

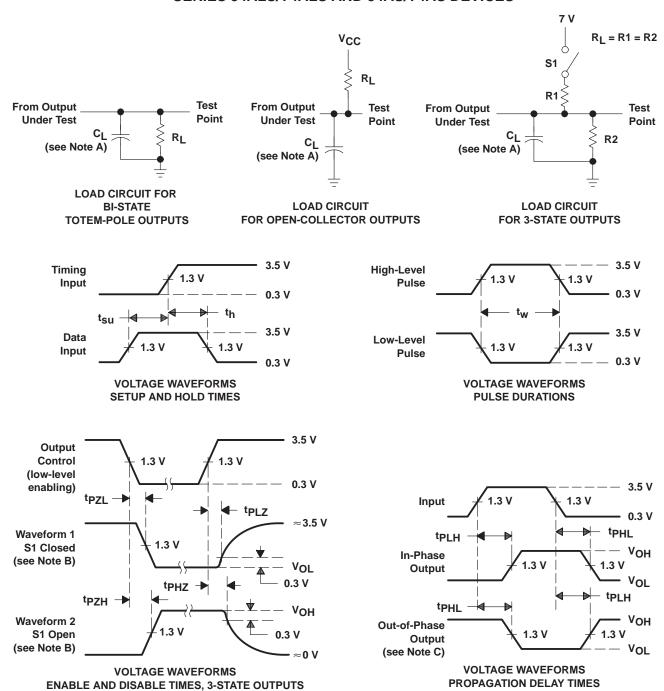
SDAS191A - APRIL 1982 - REVISED DECEMBER 1994

switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	C _L = 5 R _L = 5		C _L = 50 pF R _L = 500 Ω T _A = MIN to		Ω ,			
			MIN	MAX	MIN	MAX			
			IVIIIV	IVIAA	IVIIIV	IVIAA			
^t PLH	A or B	,	1	6.5	1	5.5	ns		
^t PHL	AUD	1	1	6.5	1	5.5	115		

 $^{^\}dagger$ For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

PARAMETER MEASUREMENT INFORMATION SERIES 54ALS/74ALS AND 54AS/74AS DEVICES



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
- D. All input pulses have the following characteristics: PRR \leq 1 MHz, t_{Γ} = t_{f} = 2 ns, duty cycle = 50%.
- E. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms







i.com 28-Feb-2005

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
5962-86842012A	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
5962-8684201CA	ACTIVE	CDIP	J	14	1	None	Call TI	Level-NC-NC-NC
5962-8684201DA	ACTIVE	CFP	W	14	1	None	Call TI	Level-NC-NC-NC
JM38510/37401B2A	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
JM38510/37401BCA	ACTIVE	CDIP	J	14	1	None	Call TI	Level-NC-NC-NC
SN54ALS08J	ACTIVE	CDIP	J	14	1	None	Call TI	Level-NC-NC-NC
SN54AS08J	ACTIVE	CDIP	J	14	1	None	Call TI	Level-NC-NC-NC
SN74ALS08D	ACTIVE	SOIC	D	14	50	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74ALS08DR	ACTIVE	SOIC	D	14	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74ALS08N	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74ALS08N3	OBSOLETE	PDIP	N	14		None	Call TI	Call TI
SN74ALS08NSR	ACTIVE	SO	NS	14	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74AS08D	ACTIVE	SOIC	D	14	50	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74AS08DR	ACTIVE	SOIC	D	14	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74AS08N	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74AS08N3	OBSOLETE	PDIP	N	14		None	Call TI	Call TI
SN74AS08NSR	ACTIVE	SO	NS	14	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SNJ54ALS08FK	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
SNJ54ALS08J	ACTIVE	CDIP	J	14	1	None	Call TI	Level-NC-NC-NC
SNJ54ALS08W	ACTIVE	CFP	W	14	1	None	Call TI	Level-NC-NC-NC
SNJ54AS08FK	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
SNJ54AS08J	ACTIVE	CDIP	J	14	1	None	Call TI	Level-NC-NC-NC
SNJ54AS08W	ACTIVE	CFP	W	14	1	None	Call TI	Level-NC-NC-NC

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

None: Not yet available Lead (Pb-Free).

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean "Pb-Free" and in addition, uses package materials that do not contain halogens, including bromine (Br) or antimony (Sb) above 0.1% of total product weight.

⁽²⁾ Eco Plan - May not be currently available - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.



PACKAGE OPTION ADDENDUM

28-Feb-2005

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDECindustry standard classifications, and peak solder temperature.

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